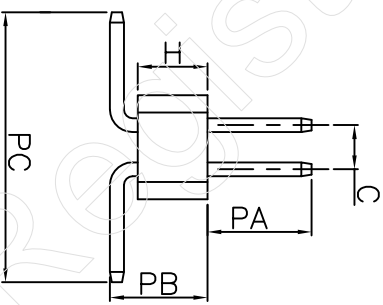
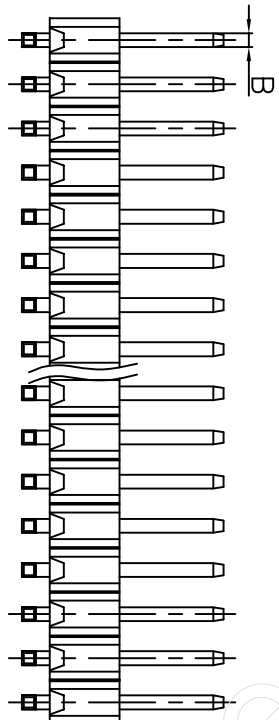
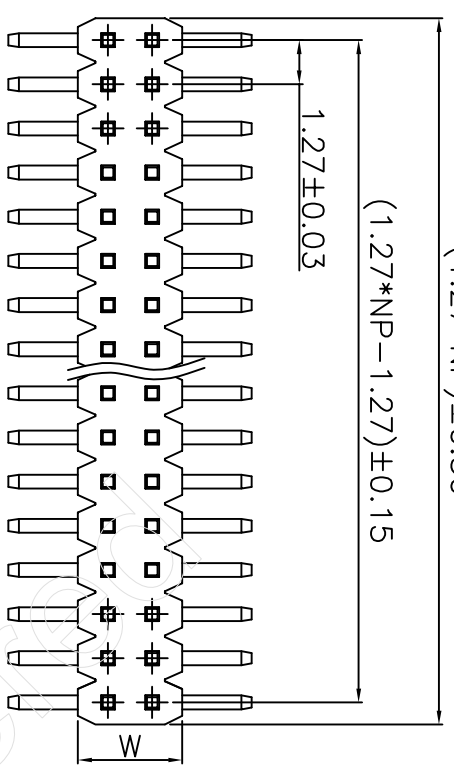


(1.27*NP)±0.30

(1.27*NP-1.27)±0.15

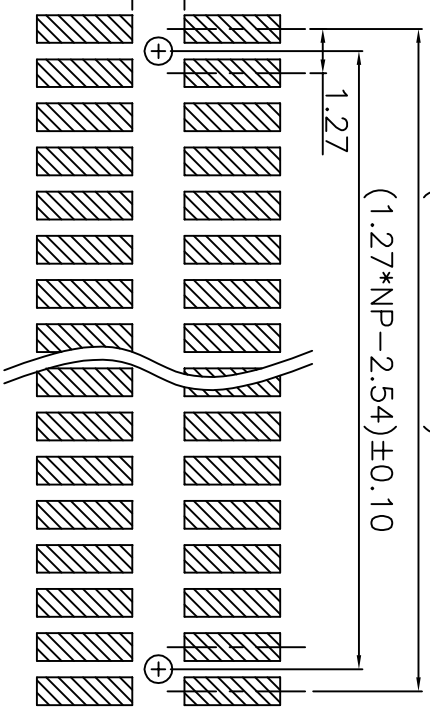
1.27±0.03



(1.27*NP-1.27)±0.10

1.27

1.50



PCB LAYOUT

版本号	变更说明	日期	签名
A	NEW	12.07.09	Zeng_gc

- Specifications
1. Current Ratings: 2Amps
 2. Insulation Resistance: 5000 MΩ min.
 3. Dielectric withstanding Voltage: AC 500V
 4. Contact Resistance: 30 mΩ max.
 5. Operating Temperature: -40°C to +105°C
 6. Contact Material: Copper Clad Steel
 7. Insulation Material: Asfollows
 8. Plated: Asfollows

H	W	B	C	D
2.54	4.30			
2.00	3.00			
1.70	3.00			
1.60	3.00	0.40/0.46	1.27/2.54	0.65/0.75
1.50	3.00/3.40			
1.00	3.40/5.00			
0.65	3.00			

深圳市永连旺电子有限公司

公差标准	尺寸公差	角度
0	±0.25	0.°
.00	±0.20	0.°
.000	±0.10	.00°

品名	材料	制料	图核	比例	单位	mm	核	页码	1/4	尺码	A4
挂针PH.27 双排 23NP 弯四槽 SMT系列				1:1							